# LNK302/304-306 LinkSwitch®TN Family Lowest Component Count, Energy Efficient

POWER<sup>®</sup> INTEGRATIONS

### **Product Highlights**

#### **Cost Effective Linear/Cap Dropper Replacement**

**Off-Line Switcher IC** 

- Lowest cost and component count buck converter solution
- Fully integrated auto-restart for short-circuit and open loop fault protection saves external component costs
- LNK302 uses a simplified controller without auto-restart for very low system cost
- 66 kHz operation with accurate current limit allows low cost off-the-shelf 1 mH inductor for up to 120 mA output current
- Tight tolerances and negligible temperature variation
- High breakdown voltage of 700 V provides excellent input surge withstand
- Frequency jittering dramatically reduces EMI (~10 dB) – minimizes EMI filter cost
- High thermal shutdown temperature (+135 °C minimum)

## Much Higher Performance over Discrete Buck and Passive Solutions

- Supports buck, buck-boost and flyback topologies
- System level thermal overload, output short-circuit and open control loop protection
- Excellent line and load regulation even with typical configuration
- High bandwidth provides fast turn-on with no overshoot
- Current limit operation rejects line ripple
- Universal input voltage range (85 VAC to 265 VAC)
- Built-in current limit and hysteretic thermal protection
- Higher efficiency than passive solutions
- Higher power factor than capacitor-fed solutions
- Entirely manufacturable in SMD

#### **EcoSmart**<sup>®</sup> – Extremely Energy Efficient

- Consumes typically only 50/80 mW in self-powered buck topology at 115/230 VAC input with no load (opto feedback)
- Consumes typically only 7/12 mW in flyback topology with external bias at 115/230 VAC input with no load
- Meets California Energy Commission (CEC), Energy Star, and EU requirements

#### Applications

- Appliances and timers
- LED drivers and industrial controls

### Description

*LinkSwitch-TN* is specifically designed to replace all linear and capacitor-fed (cap dropper) non-isolated power supplies in the

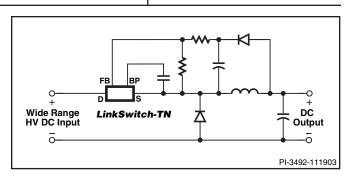


Figure 1. Typical Buck Converter Application (See Application Examples Section for Other Circuit Configurations).

OUTPUT CURRENT TABLE <sup>1</sup>							
PRODUCT⁴	230 VA	C ±15%	85-265 VAC				
PRODUCT		CCM <sup>3</sup>		CCM <sup>3</sup>			
LNK302P or G	63 mA	80 mA	63 mA	80 mA			
LNK304P or G	120 mA	170 mA	120 mA	170 mA			
LNK305P or G	175 mA	280 mA	175 mA	280 mA			
LNK306P or G	225 mA	360 mA	225 mA	360 mA			

*Table 1.* Notes: **1.** Typical output current in a non-isolated buck converter. Output power capability depends on respective output voltage. See Key Applications Considerations Section for complete description of assumptions, including fully discontinuous conduction mode (DCM) operation. **2.** Mostly discontinuous conduction mode. **3.** Continuous conduction mode. **4.** Packages: P: DIP-8B, G: SMD-8B. For lead-free package options, see Part Ordering Information.

under 360 mA output current range at equal system cost while offering much higher performance and energy efficiency.

*LinkSwitch-TN* devices integrate a 700 V power MOSFET, oscillator, simple On/Off control scheme, a high voltage switched current source, frequency jittering, cycle-by-cycle current limit and thermal shutdown circuitry onto a monolithic IC. The startup and operating power are derived directly from the voltage on the DRAIN pin, eliminating the need for a bias supply and associated circuitry in buck or flyback converters. The fully integrated auto-restart circuit in the LNK304-306 safely limits output power during fault conditions such as short-circuit or open loop, reducing component count and system-level load protection cost. A local supply provided by the IC allows use of a non-safety graded optocoupler acting as a level shifter to further enhance line and load regulation performance in buck and buck-boost converters, if required.

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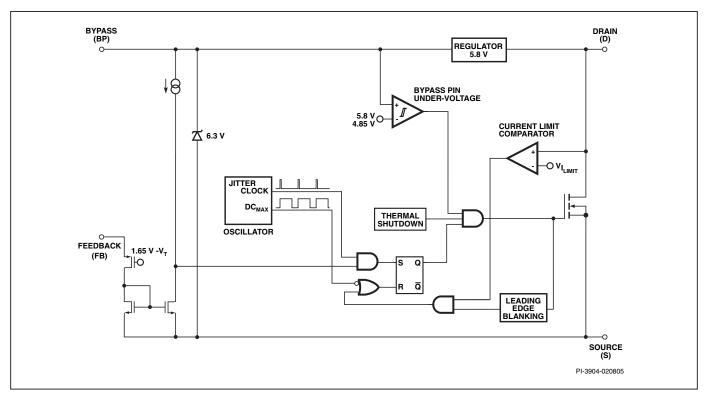


Figure 2a. Functional Block Diagram (LNK302).

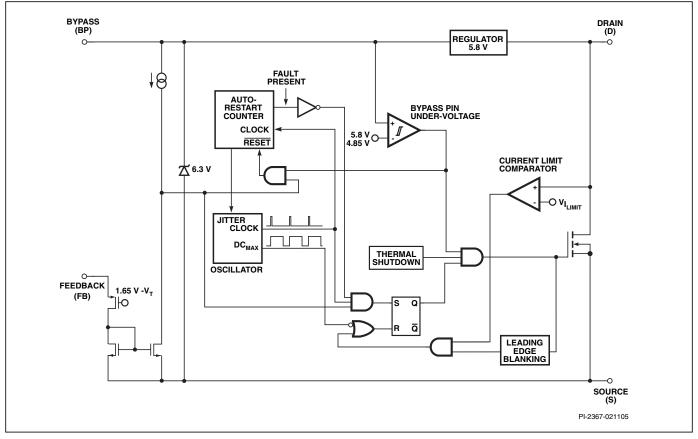


Figure 2b. Functional Block Diagram (LNK304-306).



### **Pin Functional Description**

#### DRAIN (D) Pin:

Power MOSFET drain connection. Provides internal operating current for both start-up and steady-state operation.

#### **BYPASS (BP) Pin:**

Connection point for a 0.1  $\mu F$  external bypass capacitor for the internally generated 5.8 V supply.

#### FEEDBACK (FB) Pin:

During normal operation, switching of the power MOSFET is controlled by this pin. MOSFET switching is terminated when a current greater than 49  $\mu$ A is delivered into this pin.

#### SOURCE (S) Pin:

This pin is the power MOSFET source connection. It is also the ground reference for the BYPASS and FEEDBACK pins.

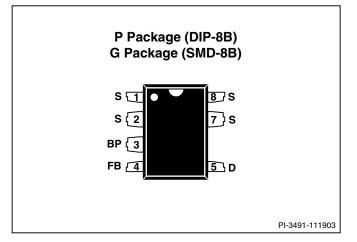


Figure 3. Pin Configuration.

# *LinkSwitch-TN* Functional Description

*LinkSwitch-TN* combines a high voltage power MOSFET switch with a power supply controller in one device. Unlike conventional PWM (pulse width modulator) controllers, *LinkSwitch-TN* uses a simple ON/OFF control to regulate the output voltage. The *LinkSwitch-TN* controller consists of an oscillator, feedback (sense and logic) circuit, 5.8 V regulator, BYPASS pin undervoltage circuit, over-temperature protection, frequency jittering, current limit circuit, leading edge blanking and a 700 V power MOSFET. The *LinkSwitch-TN* incorporates additional circuitry for auto-restart.

#### Oscillator

The typical oscillator frequency is internally set to an average of 66 kHz. Two signals are generated from the oscillator: the maximum duty cycle signal ( $DC_{MAX}$ ) and the clock signal that indicates the beginning of each cycle.

The *LinkSwitch-TN* oscillator incorporates circuitry that introduces a small amount of frequency jitter, typically 4 kHz peak-to-peak, to minimize EMI emission. The modulation rate of the frequency jitter is set to 1 kHz to optimize EMI reduction for both average and quasi-peak emissions. The frequency jitter should be measured with the oscilloscope triggered at the falling edge of the DRAIN waveform. The waveform in Figure 4 illustrates the frequency jitter of the *LinkSwitch-TN*.

#### **Feedback Input Circuit**

The feedback input circuit at the FB pin consists of a low impedance source follower output set at 1.65 V. When the current delivered into this pin exceeds  $49 \,\mu$ A, a low logic level (disable) is generated at the output of the feedback circuit. This output is sampled at the beginning of each cycle on the rising edge of the clock signal. If high, the power MOSFET is turned on for that cycle (enabled), otherwise the power MOSFET remains off (disabled). Since the sampling is done only at the beginning of each cycle, subsequent changes in the FB pin voltage or current during the remainder of the cycle are ignored.

#### 5.8 V Regulator and 6.3 V Shunt Voltage Clamp

The 5.8 V regulator charges the bypass capacitor connected to the BYPASS pin to 5.8 V by drawing a current from the voltage on the DRAIN, whenever the MOSFET is off. The BYPASS pin is the internal supply voltage node for the *LinkSwitch-TN*. When the MOSFET is on, the *LinkSwitch-TN* runs off of the energy stored in the bypass capacitor. Extremely low power consumption of the internal circuitry allows the *LinkSwitch-TN* to operate continuously from the current drawn from the DRAIN pin. A bypass capacitor value of 0.1  $\mu$ F is sufficient for both high frequency decoupling and energy storage.

In addition, there is a 6.3 V shunt regulator clamping the BYPASS pin at 6.3 V when current is provided to the BYPASS pin through an external resistor. This facilitates powering of *LinkSwitch-TN* externally through a bias winding to decrease the no-load consumption to about 50 mW.

#### **BYPASS Pin Under-Voltage**

The BYPASS pin under-voltage circuitry disables the power MOSFET when the BYPASS pin voltage drops below 4.85 V. Once the BYPASS pin voltage drops below 4.85 V, it must rise back to 5.8 V to enable (turn-on) the power MOSFET.

#### **Over-Temperature Protection**

The thermal shutdown circuitry senses the die temperature. The threshold is set at 142 °C typical with a 75 °C hysteresis. When the die temperature rises above this threshold (142 °C) the power MOSFET is disabled and remains disabled until the die temperature falls by 75 °C, at which point it is re-enabled.

#### **Current Limit**

The current limit circuit senses the current in the power MOSFET. When this current exceeds the internal threshold  $(I_{LIMIT})$ , the



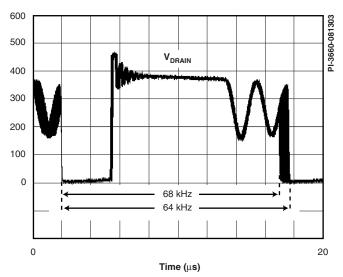


Figure 4. Frequency Jitter.

power MOSFET is turned off for the remainder of that cycle. The leading edge blanking circuit inhibits the current limit comparator for a short time  $(t_{LEB})$  after the power MOSFET is turned on. This leading edge blanking time has been set so that current spikes caused by capacitance and rectifier reverse recovery time will not cause premature termination of the switching pulse.

#### Auto-Restart (LNK304-306 only)

In the event of a fault condition such as output overload, output short, or an open loop condition, *LinkSwitch-TN* enters into autorestart operation. An internal counter clocked by the oscillator gets reset every time the FB pin is pulled high. If the FB pin is not pulled high for 50 ms, the power MOSFET switching is disabled for 800 ms. The auto-restart alternately enables and disables the switching of the power MOSFET until the fault condition is removed.

### **Applications Example**

#### A 1.44 W Universal Input Buck Converter

The circuit shown in Figure 5 is a typical implementation of a

12 V, 120 mA non-isolated power supply used in appliance control such as rice cookers, dishwashers or other white goods. This circuit may also be applicable to other applications such as night-lights, LED drivers, electricity meters, and residential heating controllers, where a non-isolated supply is acceptable.

The input stage comprises fusible resistor RF1, diodes D3 and D4, capacitors C4 and C5, and inductor L2. Resistor RF1 is a flame proof, fusible, wire wound resistor. It accomplishes several functions: a) Inrush current limitation to safe levels for rectifiers D3 and D4; b) Differential mode noise attenuation; c) Input fuse should any other component fail short-circuit (component fails safely open-circuit without emitting smoke, fire or incandescent material).

The power processing stage is formed by the *LinkSwitch-TN*, freewheeling diode D1, output choke L1, and the output capacitor C2. The LNK304 was selected such that the power supply operates in the mostly discontinuous-mode (MDCM). Diode D1 is an ultra-fast diode with a reverse recovery time ( $t_{rr}$ ) of approximately 75 ns, acceptable for MDCM operation. For continuous conduction mode (CCM) designs, a diode with a  $t_{rr}$  of  $\leq$ 35 ns is recommended. Inductor L1 is a standard off-the-shelf inductor with appropriate RMS current rating (and acceptable temperature rise). Capacitor C2 is the output filter capacitor; its primary function is to limit the output voltage ripple. The output voltage ripple is a stronger function of the ESR of the output capacitor than the value of the capacitor itself.

To a first order, the forward voltage drops of D1 and D2 are identical. Therefore, the voltage across C3 tracks the output voltage. The voltage developed across C3 is sensed and regulated via the resistor divider R1 and R3 connected to U1's FB pin. The values of R1 and R3 are selected such that, at the desired output voltage, the voltage at the FB pin is 1.65 V.

Regulation is maintained by skipping switching cycles. As the output voltage rises, the current into the FB pin will rise. If this exceeds  $I_{FB}$  then subsequent cycles will be skipped until the current reduces below  $I_{FB}$ . Thus, as the output load is reduced, more cycles will be skipped and if the load increases, fewer

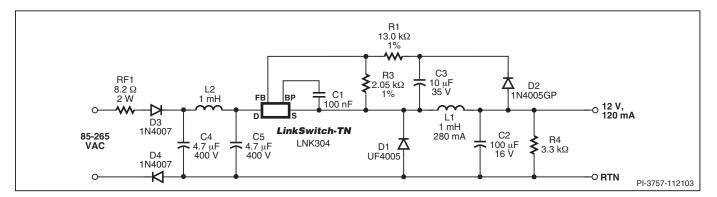


Figure 5. Universal Input, 12 V, 120 mA Constant Voltage Power Supply Using LinkSwitch-TN.



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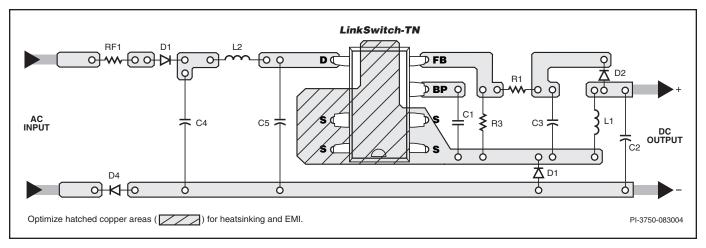


Figure 6. Recommended Printed Circuit Layout for LinkSwitch-TN in a Buck Converter Configuration.

cycles are skipped. To provide overload protection if no cycles are skipped during a 50 ms period, *LinkSwitch-TN* will enter auto-restart (LNK304-306), limiting the average output power to approximately 6% of the maximum overload power. Due to tracking errors between the output voltage and the voltage across C3 at light load or no load, a small pre-load may be required (R4). For the design in Figure 5, if regulation to zero load is required, then this value should be reduced to  $2.4 \text{ k}\Omega$ .

### **Key Application Considerations**

#### LinkSwitch-TN Design Considerations

#### **Output Current Table**

Data sheet maximum output current table (Table 1) represents the maximum practical continuous output current for both mostly discontinuous conduction mode (MDCM) and continuous conduction mode (CCM) of operation that can be delivered from a given *LinkSwitch-TN* device under the following assumed conditions:

- 1) Buck converter topology.
- The minimum DC input voltage is ≥70 V. The value of input capacitance should be large enough to meet this criterion.
- 3) For CCM operation a KRP\* of 0.4.
- 4) Output voltage of 12 VDC.
- 5) Efficiency of 75%.
- A catch/freewheeling diode with t<sub>rr</sub> ≤75 ns is used for MDCM operation and for CCM operation, a diode with t<sub>rr</sub> ≤35 ns is used.
- 7) The part is board mounted with SOURCE pins soldered to a sufficient area of copper to keep the SOURCE pin temperature at or below 100 °C.
- \*KRP is the ratio of ripple to peak inductor current.

# **LinkSwitch-TN** Selection and Selection Between MDCM and CCM Operation

Select the *LinkSwitch-TN* device, freewheeling diode and output inductor that gives the lowest overall cost. In general, MDCM provides the lowest cost and highest efficiency converter. CCM designs require a larger inductor and ultra-fast ( $t_{rr} \leq 35$  ns) freewheeling diode in all cases. It is lower cost to use a larger *LinkSwitch-TN* in MDCM than a smaller *LinkSwitch-TN* in CCM because of the additional external component costs of a CCM design. However, if the highest output current is required, CCM should be employed following the guidelines below.

#### **Topology Options**

*LinkSwitch-TN* can be used in all common topologies, with or without an optocoupler and reference to improve output voltage tolerance and regulation. Table 2 provide a summary of these configurations. For more information see the Application Note – *LinkSwitch-TN* Design Guide.

#### **Component Selection**

Referring to Figure 5, the following considerations may be helpful in selecting components for a *LinkSwitch-TN* design.

#### Freewheeling Diode D1

Diode D1 should be an ultra-fast type. For MDCM, reverse recovery time  $t_{rr} \leq 75$  ns should be used at a temperature of 70 °C or below. Slower diodes are not acceptable, as continuous mode operation will always occur during startup, causing high leading edge current spikes, terminating the switching cycle prematurely, and preventing the output from reaching regulation. If the ambient temperature is above 70 °C then a diode with  $t_{rr} \leq 35$  ns should be used.

For CCM an ultra-fast diode with reverse recovery time  $t_{rr} \leq 35$  ns should be used. A slower diode may cause excessive



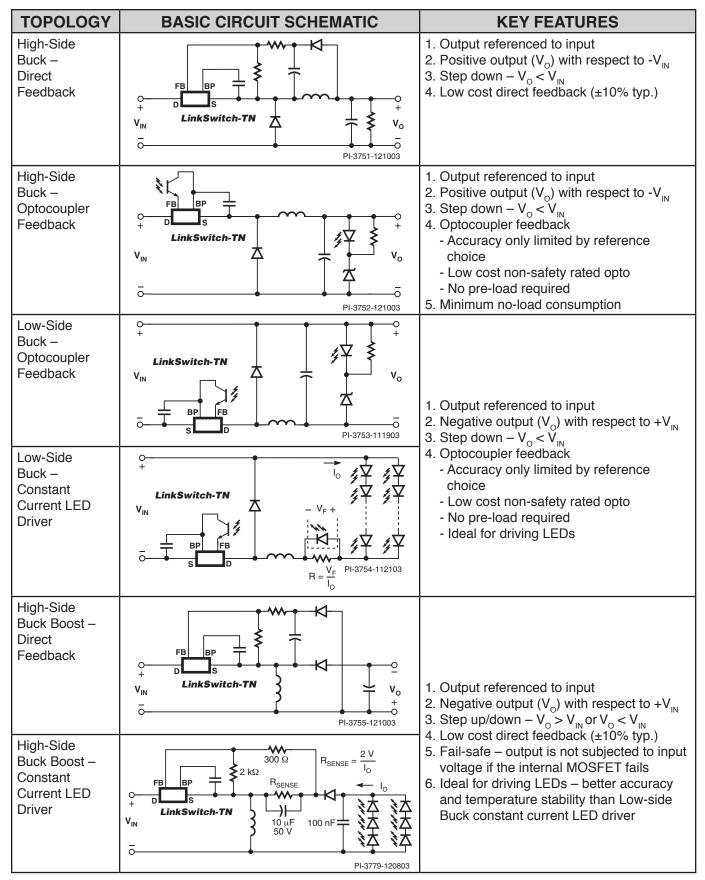


 Table 2. Common Circuit Configurations Using LinkSwitch-TN. (continued on next page)



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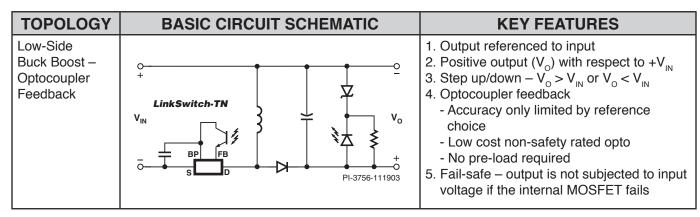


Table 2 (cont). Common Circuit Configurations Using LinkSwitch-TN.

leading edge current spikes, terminating the switching cycle prematurely and preventing full power delivery.

Fast and slow diodes should never be used as the large reverse recovery currents can cause excessive power dissipation in the diode and/or exceed the maximum drain current specification of *LinkSwitch-TN*.

#### Feedback Diode D2

Diode D2 can be a low-cost slow diode such as the 1N400X series, however it should be specified as a glass passivated type to guarantee a specified reverse recovery time. To a first order, the forward drops of D1 and D2 should match.

#### Inductor L1

Choose any standard off-the-shelf inductor that meets the design requirements. A "drum" or "dog bone" "I" core inductor is recommended with a single ferrite element due to to its low cost and very low audible noise properties. The typical inductance value and RMS current rating can be obtained from the *LinkSwitch-TN* design spreadsheet available within the *PI Expert* design suite from Power Integrations. Choose L1 greater than or equal to the typical calculated inductance with RMS current rating greater than or equal to calculated RMS inductor current.

#### **Capacitor C2**

The primary function of capacitor C2 is to smooth the inductor current. The actual output ripple voltage is a function of this capacitor's ESR. To a first order, the ESR of this capacitor should not exceed the rated ripple voltage divided by the typical current limit of the chosen *LinkSwitch-TN*.

#### Feedback Resistors R1 and R3

The values of the resistors in the resistor divider formed by R1 and R3 are selected to maintain 1.65 V at the FB pin. It is recommended that R3 be chosen as a standard 1% resistor of  $2 k\Omega$ . This ensures good noise immunity by biasing the feedback network with a current of approximately 0.8 mA.

#### Feedback Capacitor C3

Capacitor C3 can be a low cost general purpose capacitor. It provides a "sample and hold" function, charging to the output voltage during the off time of *LinkSwitch-TN*. Its value should be 10  $\mu$ F to 22  $\mu$ F; smaller values cause poorer regulation at light load conditions.

#### Pre-load Resistor R4

In high-side, direct feedback designs where the minimum load is <3 mA, a pre-load resistor is required to maintain output regulation. This ensures sufficient inductor energy to pull the inductor side of the feedback capacitor C3 to input return via D2. The value of R4 should be selected to give a minimum output load of 3 mA.

In designs with an optocoupler the Zener or reference bias current provides a 1 mA to 2 mA minimum load, preventing "pulse bunching" and increased output ripple at zero load.

#### LinkSwitch-TN Layout Considerations

In the buck or buck-boost converter configuration, since the SOURCE pins in *LinkSwitch-TN* are switching nodes, the copper area connected to SOURCE should be minimized to minimize EMI within the thermal constraints of the design.

In the boost configuration, since the SOURCE pins are tied to DC return, the copper area connected to SOURCE can be maximized to improve heatsinking.

The loop formed between the *LinkSwitch-TN*, inductor (L1), freewheeling diode (D1), and output capacitor (C2) should be kept as small as possible. The BYPASS pin capacitor C1 (Figure 6) should be located physically close to the SOURCE (S) and BYPASS (BP) pins. To minimize direct coupling from switching nodes, the *LinkSwitch-TN* should be placed away from AC input lines. It may be advantageous to place capacitors C4 and C5 in-between *LinkSwitch-TN* and the AC input. The second rectifier diode D4 is optional, but may

be included for better EMI performance and higher line surge withstand capability.

#### **Quick Design Checklist**

As with any power supply design, all LinkSwitch-TN designs should be verified for proper functionality on the bench. The following minimum tests are recommended:

- 1) Adequate DC rail voltage check that the minimum DC input voltage does not fall below 70 VDC at maximum load, minimum input voltage.
- 2) Correct Diode Selection UF400x series diodes are recommended only for designs that operate in MDCM at an ambient of 70 °C or below. For designs operating in continuous conduction mode (CCM) and/or higher ambients, then a diode with a reverse recovery time of 35 ns or better, such as the BYV26C, is recommended.
- 3) Maximum drain current verify that the peak drain current is below the data sheet peak drain specification under

worst-case conditions of highest line voltage, maximum overload (just prior to auto-restart) and highest ambient temperature.

4) Thermal check - at maximum output power, minimum input voltage and maximum ambient temperature, verify that the LinkSwitch-TN SOURCE pin temperature is 100 °C or below. This figure ensures adequate margin due to variations in  $R_{DS(ON)}$  from part to part. A battery powered thermocouple meter is recommended to make measurements when the SOURCE pins are a switching node. Alternatively, the ambient temperature may be raised to indicate margin to thermal shutdown.

In a *LinkSwitch-TN* design using a buck or buck boost converter topology, the SOURCE pin is a switching node. Oscilloscope measurements should therefore be made with probe grounded to a DC voltage, such as primary return or DC input rail, and not to the SOURCE pins. The power supply input must always be supplied from an isolated source (e.g. via an isolation transformer).

ABSOLUTE MAXIMUM RATINGS <sup>(1,5)</sup>								
DRAIN Voltage0.3 V to 700 V								
Peak DRAIN Current (LNK302)200 mA (375 mA) <sup>(2)</sup>								
Peak DRAIN Current (LNK304)400 mA (750 mA) <sup>(2)</sup>	2. The higher peak DRAIN current is allowed if the DRAIN							
Peak DRAIN Current (LNK305)800 mA(1500 mA) <sup>(2)</sup>	to SOURCE voltage does not exceed 400 V.							
Peak DRAIN Current (LNK306)1400 mA (2600 mA) <sup>(2)</sup>	3. Normally limited by internal circuitry.							
FEEDBACK Voltage0.3 V to 9 V	4. 1/16 in. from case for 5 seconds.							
FEEDBACK Current100 mA	5. Maximum ratings specified may be applied, one at a time,							
BYPASS Voltage0.3 V to 9 V	without causing permanent damage to the product.							
Storage Temperature65 °C to 150 °C	Exposure to Absolute Maximum Rating conditions for							
Operating Junction Temperature <sup>(3)</sup> 40 °C to 150 °C	extended periods of time may affect product reliability.							
Lead Temperature <sup>(4)</sup>								

### THERMAL IMPEDANCE

Thermal Impedance: P or G Package:	Notes:
$(\theta_{IA})$ 70 °C/W <sup>(2)</sup> ; 60 °C/W <sup>(3)</sup>	1. Measured on pin 2 (SOURCE) close to plastic interface.
$(\theta_{\rm IC})^{(1)}$	2. Soldered to 0.36 sq. in. (232 mm <sup>2</sup> ), 2 oz. (610 g/m <sup>2</sup> ) copper clad.
	3. Soldered to 1 sq. in. (645 mm <sup>2</sup> ), 2 oz. (610 g/m <sup>2</sup> ) copper clad.

Parameter	Symbol	<b>Conditions</b> SOURCE = 0 V; T <sub>J</sub> = -40 to 125 °C See Figure 7 (Unless Otherwise Specified)		Min	Тур	Мах	Units
CONTROL FUNCTIONS							
Output	f	T - 25 °C	Average	62	66	70	kHz
Frequency	f <sub>osc</sub>	T <sub>J</sub> = 25 °C	Peak-Peak Jitter		4		KHZ
Maximum Duty Cycle	DC <sub>MAX</sub>	S2 Open		66	69	72	%
FEEDBACK Pin Turnoff Threshold Current	I <sub>FB</sub>	T <sub>J</sub> = 25 °C		30	49	68	μΑ
FEEDBACK Pin Voltage at Turnoff Threshold	V <sub>FB</sub>			1.54	1.65	1.76	v
	I <sub>S1</sub>	V <sub>FB</sub> ≥2 V (MOSFET Not Switching) See Note A			160	220	μΑ
DRAIN Supply Current	I <sub>S2</sub> FEEDBACK Open (MOSFET Switching) See Notes A, B	Open (MOSFET	LNK302/304		200	260	
			LNK305		220	280	μA
		LNK306		250	310		

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Conditions								
Parameter	Symbol	<b>Conditions</b> SOURCE = 0 V; T <sub>J</sub> = -40 to 125 °C See Figure 7 (Unless Otherwise Specified)		Min	Тур	Мах	Units	
CONTROL FUNCTIONS (cont.)								
	1	V <sub>BP</sub> = 0 V T <sub>J</sub> = 25 °C	LNK302/304	-5.5	-3.3	-1.8	mA	
BYPASS Pin	I <sub>CH1</sub>		LNK305/306	-7.5	-4.6	-2.5		
Charge Current	1	$V_{BP} = 4 V$	LNK302/304	-3.8	-2.3	-1.0		
	I <sub>CH2</sub>	T <sub>J</sub> = 25 °C	LNK305/306	-4.5	-3.3	-1.5		
BYPASS Pin Voltage	$V_{BP}$			5.55	5.8	6.10	V	
BYPASS Pin Voltage Hysteresis	V <sub>BPH</sub>			0.8	0.95	1.2	V	
BYPASS Pin Supply Current	I <sub>BPSC</sub>	See No	te D	68			μA	
CIRCUIT PROTEC	TION				<u>.</u>			
	I <sub>LIMIT</sub> (See Note E)	di/dt = 55 mA/µs T <sub>J</sub> = 25 °C	LNK302	126	136	146		
		di/dt = 250 mA/μs T <sub>J</sub> = 25 °C		145	165	185		
		di/dt = 65 mA/µs T <sub>J</sub> = 25 °C	LNK304	240	257	275		
Current Limit		di/dt = 415 mA/ $\mu$ s T <sub>J</sub> = 25 °C		271	308	345	mA	
		di/dt = 75 mA/µs T <sub>J</sub> = 25 °C	LNK305	350	375	401		
		di/dt = 500 mA/µs T <sub>J</sub> = 25 °C		396	450	504		
		di/dt = 95 mA/µs T <sub>J</sub> = 25 °C		450	482	515		
		di/dt = 610 mA/ $\mu$ s T <sub>J</sub> = 25 °C	LNK306	508	578	647		
			LNK302/304	280	360	475		
Minimum On Time	t <sub>on(MIN)</sub>		LNK305	360	460	610	ns	
			LNK306	400	500	675		

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		Conditions SOURCE = 0 V; T <sub>J</sub> = -40 to 125 °C See Figure 7 (Unless Otherwise Specified)						
Parameter	Symbol			Min	Тур	Max	Units	
CIRCUIT PROTECTION (cont.)								
Leading Edge	t <sub>LEB</sub>	$T_J = 2$		170	215		ns	
Blanking Time	LEB	See N	lote F		210			
Thermal Shutdown	T <sub>sd</sub>			135	142	150	°C	
Temperature	'SD			100	172	100	Ŭ	
Thermal Shutdown	т	See N	lote G		75		°C	
Hysteresis	T <sub>SHD</sub>				/3		Ŭ	
OUTPUT						<u>.</u>		
		LNK302	T <sub>J</sub> = 25 °C	-	48	55.2		
		I <sub>D</sub> = 13 mA	T <sub>J</sub> = 100 °C		76	88.4		
		LNK304	T <sub>J</sub> = 25 °C		24	27.6	_	
ON-State	R <sub>DS(ON)</sub>	I <sub>D</sub> = 25 mA	T <sub>J</sub> = 100 °C		38	44.2	Ω	
Resistance	- DS(ON)	LNK305	T <sub>J</sub> = 25 °C		12	13.8		
		$I_{\rm D} = 35 \text{ mA}$	T <sub>J</sub> = 100 °C		19	22.1		
		LNK306 I <sub>D</sub> = 45 mA	T <sub>J</sub> = 25 °C		7	8.1		
			T <sub>J</sub> = 100 °C		11	12.9 50		
OFF-State Drain		$V_{BP} = 6.2 \text{ V}, V_{FB} \ge$	$ V_{BP} = 6.2 \text{ V}, V_{FB} \ge 2 \text{ V},  $	2 V, LNK302/304	+		70	
Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> = 560 V, T <sub>J</sub> = 25 °C	LNK306	-		90	μA	
				-		30		
Breakdown Voltage	$BV_{DSS}$	V <sub>BP</sub> = 6.2 V, V <sub>FB</sub> ≥2 V, T <sub>1</sub> = 25 °C		700			V	
Rise Time	t <sub>R</sub>	Measured in a	a Typical Buck		50		ns	
Fall Time	t <sub>F</sub>		Application		50		ns	
DRAIN Supply					1	1		
Voltage				50			V	
Output Enable				1	1			
Delay	t <sub>en</sub>	See Fi	gure 9			10	μs	
Output Disable				1				
Setup Time	t <sub>DST</sub>				0.5		μs	
Auto-Restart		T_ = 25 °C	LNK302	N	t ot Applicat	ble	1	
ON-Time	t <sub>AR</sub>		LNK304-306	1	50		ms	
Auto-Restart			LNK302	N	Not Applicable		1	
Duty Cycle	DC <sub>AR</sub>		LNK304-306	1	6	1	%	
	DC <sub>AR</sub>				+		%	

#### NOTES:

- A. Total current consumption is the sum of I<sub>S1</sub> and I<sub>DSS</sub> when FEEDBACK pin voltage is ≥2 V (MOSFET not switching) and the sum of I<sub>S2</sub> and I<sub>DSS</sub> when FEEDBACK pin is shorted to SOURCE (MOSFET switching).
- B Since the output MOSFET is switching, it is difficult to isolate the switching current from the supply current at the DRAIN. An alternative is to measure the BYPASS pin current at 6 V.
- C. See Typical Performance Characteristics section Figure 14 for BYPASS pin start-up charging waveform.
- D. This current is only intended to supply an optional optocoupler connected between the BYPASS and FEEDBACK pins and not any other external circuitry.
- E. For current limit at other di/dt values, refer to Figure 13.
- F. This parameter is guaranteed by design.
- G. This parameter is derived from characterization.
- H. Auto-restart on time has the same temperature characteristics as the oscillator (inversely proportional to frequency).

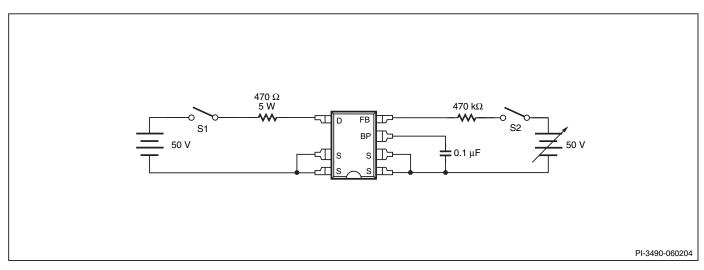


Figure 7. LinkSwitch-TN General Test Circuit.

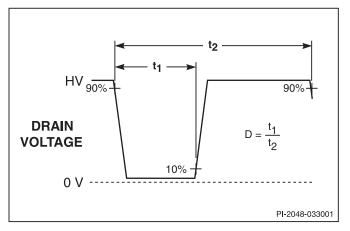
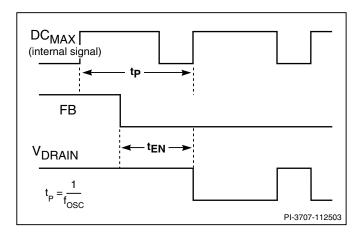
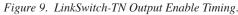


Figure 8. LinkSwitch-TN Duty Cycle Measurement.







### **Typical Performance Characteristics**

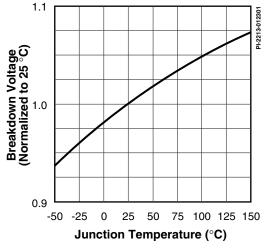


Figure 10. Breakdown vs. Temperature.

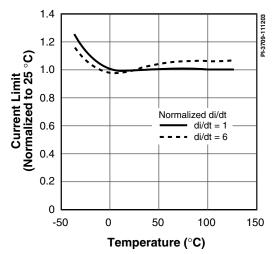


Figure 12. Current Limit vs. Temperature at Normalized di/dt.

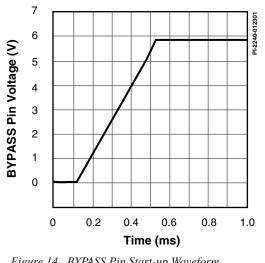


Figure 14. BYPASS Pin Start-up Waveform.

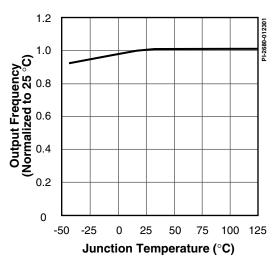


Figure 11. Frequency vs. Temperature.

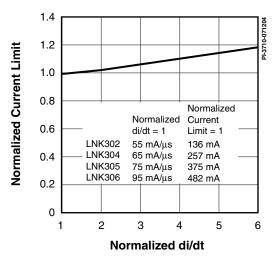
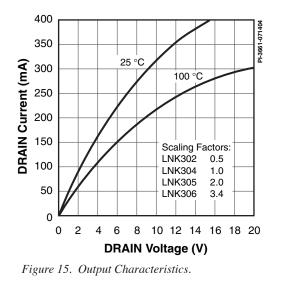


Figure 13. Current Limit vs. di/dt.





### **Typical Performance Characteristics (cont.)**

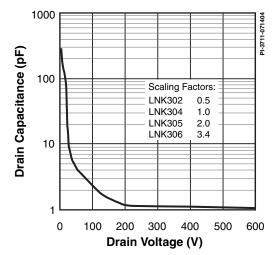
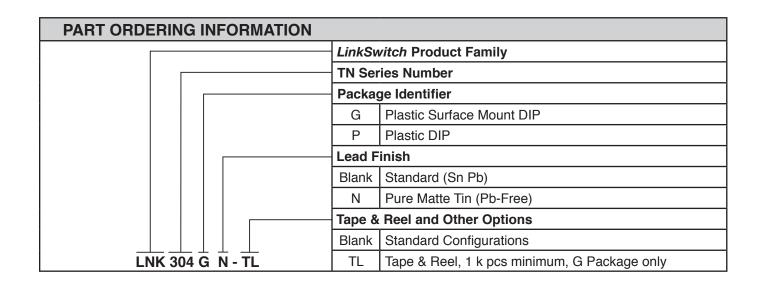
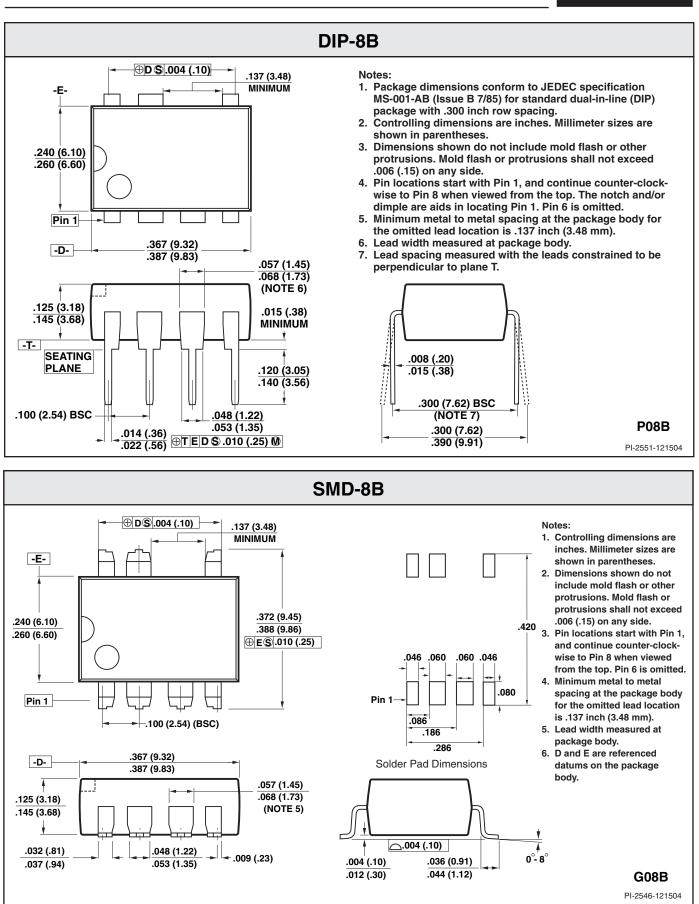


Figure 16. Coss vs. Drain Voltage.







Revision	Notes	Date
С	1) Released Final Data Sheet.	3/03
D	1) Corrected Minimum On Time.	1/04
E	1) Added LNK302.	8/04
F	1) Added lead-free ordering information.	12/04
G	<ol> <li>Minor error corrections.</li> <li>Renamed Feedback Pin Voltage parameter to Feedback Pin Voltage at Turnoff Threshold and removed condition.</li> </ol>	3/05

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